

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

SB07-03P — Schottky Barrier Diode

30V, 700mA Rectifier

Applications

· High frequency rectification (switching regulators, converters, choppers)

Features

- Low forward voltage (VF max=0.55V)
- · Low switching noise
- · Low leakage current and high reliability due to highly reliable planar structure

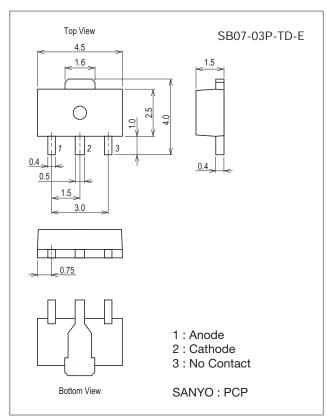
Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Repetitive Peak Reverse Voltage	VRRM		30	V
Nonrepetitive Peak Reverse Surge Voltage	VRSM		35	V
Average Output Current	IO		700	mA
Surge Forward Current	I _{FSM}	50Hz sine wave, 1 cycle	5	А
Junction Temperature	Tj		-55 to +125	°C
Storage Temperature	Tstg		-55 to +125	°C

Package Dimensions

unit : mm (typ) 7007B-001



Product & Package Information

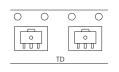
• Package : PCP

• JEITA, JEDEC : SC-62, SOT-89, TO-243

• Fast reverse recovery time (trr max=10ns)

• Minimum Packing Quantity: 1,000 pcs./reel

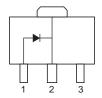
Packing Type: TD



Marking



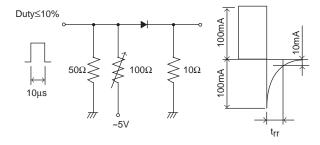
Electrical Connection



Electrical Characteristics at Ta=25°C

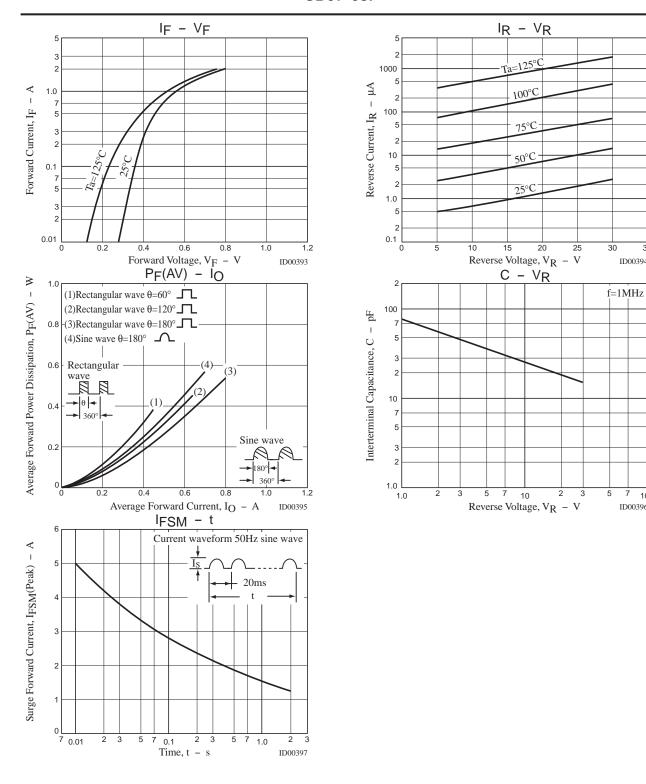
Parameter	Symbol	Conditions	Ratings			Unit
	Symbol	Conditions	min	typ	max	Utill
Reverse Voltage	VR	I _R =300μA	30			V
Forward Voltage	VF	I _F =700mA			0.55	V
Reverse Current	IR	V _R =15V			80	μΑ
Interterminal Capacitance	С	V _R =10V, f=1MHz		26		pF
Reverse Recovery Time	t _{rr}	IF=IR=100mA, See specified Test Circuit.			10	ns
Thermal Resistance	Rth(j-a)1			310		°C/W
	Rth(j-a)2	When mounted on ceramic substrate (250mm ² ×0.8mm)		120		°C/W

t_{rr} Test Circuit



Ordering Information

Device	Package	Shipping	memo	
SB07-03P-TD-E	307-03P-TD-E PCP		Pb Free	

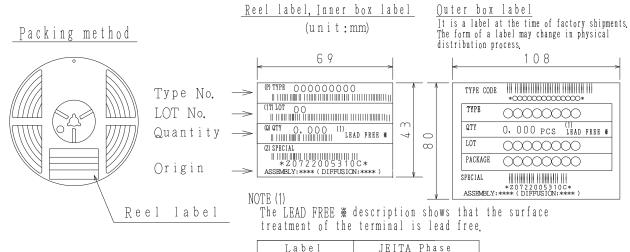


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Embossed Taping Specification SB07-03P-TD-E

1. Packing Format

Package Name	Carrier Tape	Maximum Number of devices contained (pcs)			Packing	g format		
	Туре	Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)		
PCP	PCP	1, 000	4,000	24,000	4 reels contained	6 inner boxes contained		
					Dimensions:mm (external)	Dimensions:mm (external)		
					183×72×185	440×195×210		



LEAD FREE 3

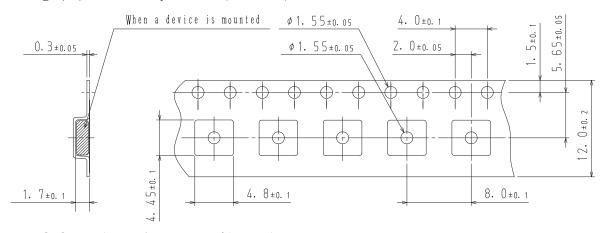
LEAD FREE 4

JEITA Phase 3A

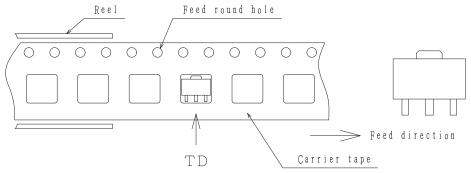
JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



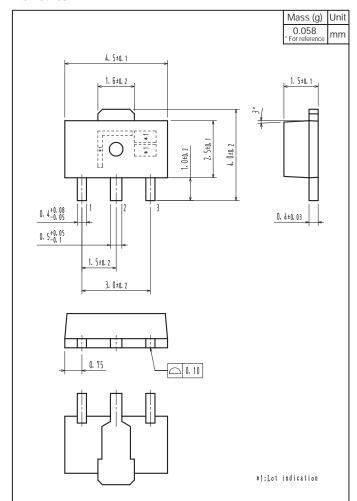
2-2. Device placement direction



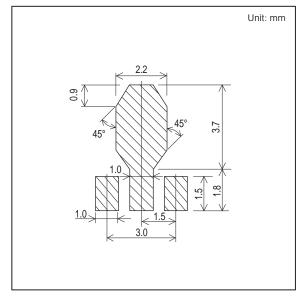
Those with pin 1 index on the feed hole side·····TD

Outline Drawing

SB07-03P-TD-E



Land Pattern Example



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